

06-29-2000

WFO 6.23

RECORDATION FORM



LY

To the Assistant Commissioner for P
Please record the attached document

101392752

1. Name of conveying party(ies):

(a) Wei-Lin Shen

(b) _____

(c) _____

Additional name(s) of conveying
party(ies) attached? XXX

Yes No

2. Name and address of
receiving party:

Name: Winbond Electronics
Corporation

Street

Address: No. 4 Creation Road III

City: Science-Based Inds. Park

State: Hsinchu, Taiwan

Zip Code: R.O.C.

3. Nature of conveyance:

☒ Assignment ☐ Merger
☐ Security ☐ Change of
Agreement ☐ Name
☐ Other _____

Execution date: June 15, 2000

Additional name(s) and
address(es) attached?

XXX
Yes No

4. Application number(s) or patent number(s):

If this document is being filed together with a new application, the
execution date of the application is _____

(a) Patent Application No(s):
09/495,752

(b) Patent No(s):

(c) Additional numbers attached? ☐ Yes ☒ No

5. Name and address of party to whom
correspondence concerning document
should be mailed:

Name: Finnegan, Henderson, Farabow,
Garrett & Dunner, L.L.P.

Street

Address: 1300 I Street, N.W.

City: Washington

State: D.C. Zip Code: 20005

6. Total number of applications
and/or patents involved: 1

7. Total Fee (37 C.F.R. § 3.41):
\$40.00

☒ Enclosed

☐ Charge to Deposit Account
No. 06-0916

8. Statement and signature:

To the best of my knowledge and belief, the foregoing information is
true and correct and any attached copy is a true copy of the original
document.

06/26/2000 STEFFERA 00000051 09495752

03 FC:581

Richard W. Burqujian

Name of person signing

Registration No. 31,744

40.00

Signature

Date

Total number of pages including all attachments? 2

20-JUN-2000 11:40 FROM WINBOND AECO

TO FINNEGAN

P.08

58-005

SOLE/JOINT INVENTION
(Worldwide Rights - Foreign Use)

Attorney Docket No.: 6484.0058

ASSIGNMENT

WHEREAS I/We, the below named inventor, hereinafter referred to as Assignor, have made an invention entitled DEEP TRENCH DRAM WITH SOI AND STI for which I/We filed an application for United States Letters Patent on February 1, 2000 (Serial No. 09/495,752); and

WHEREAS, Winbond Electronics Corporation, a corporation of Taiwan whose post office address is No. 4 Creation Road III, Science-Based Industrial Park, Hsinchu, Taiwan R.O.C. (hereinafter referred to as Assignee), is desirous of securing the entire right, title, and interest in and to this invention in all countries throughout the world, and in and to the application for United States Letters Patent on this invention and the Letters Patent to be issued upon this application:

NOW THEREFORE, be it known that for and in consideration of the sum of One Dollar (\$1.00) in hand paid and other good and valuable consideration the receipt of which from assignee is hereby acknowledged, I/We, as assignor(s), have sold, assigned, transferred, and set over, and do hereby sell, assign, transfer, and set over unto the assignee, its lawful successors and assigns, my/our entire right, title, and interest in and to this invention and this application, and all divisions, and continuations thereof, and all Letters Patent of the United States which may be granted thereon, and all reissues thereof, and all rights to claim priority on the basis of such application, and all applications for Letters Patent which may hereafter be filed for this invention in any foreign country and all Letters Patent which may be granted on this invention in any foreign country, and all extensions, renewals, and reissues thereof; and I/We hereby authorize and request the Commissioner of Patents and Trademarks of the United States and any official of any foreign country whose duty it is to issue patents on applications as described above, to issue all Letters Patent for this invention to assignee, its successors and assigns, in accordance with the terms of this Assignment;

AND, I/WE HEREBY covenant that I/We have the full right to convey the interest assigned by this Assignment, and I/We have not executed and will not execute any agreement in conflict with this Assignment;

AND, I/WE HEREBY further covenant and agree that I/We will, without further consideration, communicate with assignee, its successors and assigns, any facts known to me/us respecting this invention, and testify in any legal proceeding, sign all lawful papers when called upon to do so, execute and deliver any and all papers that may be necessary or desirable to perfect the title to this invention in said assignee, its successors or assigns, execute all divisional, continuation, and reissue applications, make all rightful oaths and generally do everything possible to aid assignee, its successors and assigns, to obtain and enforce proper patent protection for this invention in the United States and any foreign country, it being understood that any expense incident to the execution of such papers shall be borne by the assignee, its successors and assigns.

AND, I/WE HEREBY authorize and request the attorneys I/we have empowered in the Declaration and Power of Attorney in this application to insert here in parentheses (Application No. 09/495,752, filed February 1, 2000) the filing date and application number of said application when known.

WEI-LIN SHEN

FULL NAME OF SOLE OR FIRST INVENTOR

Wei-Lin Shen

INVENTOR'S SIGNATURE

2000, 6, 15

DATE